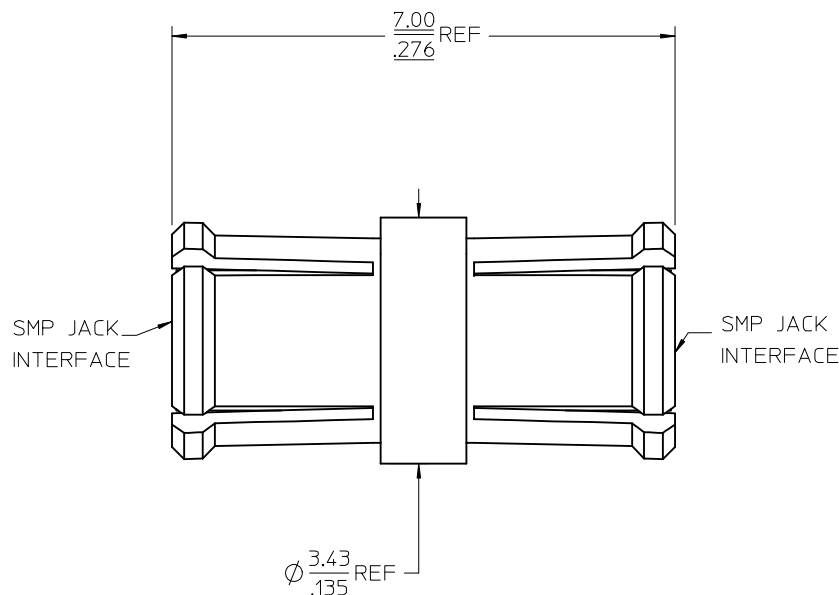
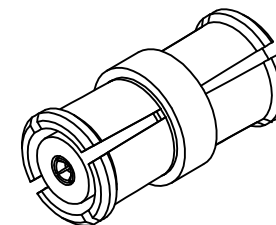


MATERIALS AND FINISHES

BODY BERYLLIUM COPPER
PLATED GOLD

CENTER CONTACT BERYLLIUM COPPER
PLATED GOLD

INSULATOR TEFLON



MIL-STD-348A, FIG. 326.1	INTERFACE
SPECIFICATION	DESCRIPTION

73415-3022	PLACE 73415-3020 INTO SMALL TRAY 897077-0308
73415-3021	PLACE 73415-3020 ONE PER BAG
73415-3020	BULK PACK
PART NO.	DESCRIPTION

CHG: ADDED 73415-3021
& -3022

EC NO: URF2009-0353
2009/01/05
DRWN:CLI
CHKD:
2009/01/06
APPR:MHUANG
2009/01/06

QUALITY
SYMBOLS
▼=0
▽=0
REV

GENERAL TOLERANCES
(UNLESS SPECIFIED)

	mm	INCH
4 PLACES	$\pm .---$	$\pm .---$
3 PLACES	$\pm .---$	$\pm .---$
2 PLACES	$\pm .---$	$\pm .---$
1 PLACE	$\pm .---$	$\pm .---$

ANGULAR $\pm 2^\circ$

DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE
MM/IN

DRAWN BY	DATE
SSS	03/01/28

CHECKED BY	DATE
TEF	03/01/28

APPROVED BY	DATE
GMH	03/01/28

MATERIAL NO.

SEE TABLE

SIZE C

SCALE

DESIGN UNITS
METRIC

THIRD ANGLE
PROJECTION

SMP JACK ADAPTER
SMP-J/J/ADP

MOLEX INCORPORATED

DOCUMENT NO.

SD-73415-302

SHEET NO.
1 OF 1

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